

SPECIFICATION FOR APPROVAL

CUSTOMER : _____

PRODUCT TYPE : SMD GLASS SEALING XTAL 3.2 × 2.5

NOMINAL FREQ. : 12.000000MHz

TXC P/N : 7V12000011

REVISION : A4

CUSTOMER P/N : _____

PM / SALES : _____

DATE : _____

CUSTOMER SIGNATURE & Date _____

- (1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.
- (4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

MSL:Level 1
RoHS Compliant

Pb used in sealing glass material is exempt from EU directive

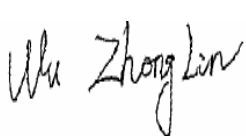
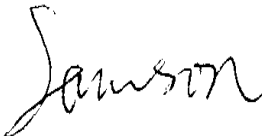

PRODUCT SPECIFICATION SHEET

PRODUCT TYPE : SMD GLASS SEALING XTAL 3.2 × 2.5

NOMINAL FREQ. : 12.000000MHz

TXC P/N : 7V12000011

REVISION : A4 **For Reference Only**

| PE/RD | QA | MFG |
|---|---|--|
|  |  |  |
| 23-Jun-11 | 23-Jun-11 | 23-Jun-11 |

NOTE:

- (1)Lead Free Products are "Directive 2002/95/EC of The European Parliament of 27 January 2003 on the restriction of the use of certain hazardous substances (RoHS) in electrical and electronic equipment" Compliant (Attachment: SGS Test Report).
- (2)Revision "Sx" is for engineering samples only. PE/RD's approval required.
- (3)Revision "Ax" is production ready. PE, QA and MFG's approval required

**MSL:Level 1
RoHS Compliant**

Pb used in sealing glass material is exempt from EU directive

| <u>Rev</u> | <u>Revise page</u> | <u>Revise contents</u> | <u>Date</u> | <u>Ref.No.</u> | <u>Reviser</u> |
|------------|--------------------|---|-------------|----------------|----------------|
| A1 | N/A | Initial released | 9-Feb-10 | N/A | Xiaoyan Jiang |
| A2 | 2 | FL Change | 11-Oct-10 | N/A | Xiaoyan Jiang |
| A3 | 2~9 | Add the Structure Illustration | 10-Mar-11 | N/A | Xiaoyan Jiang |
| A4 | 3 | Drive Level:100 uW(Typ)Change to 10uW(Min)100 uW(Typ)200 uW(Max) | 23-Jun-11 | N/A | Xiaoyan Jiang |
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Spec Sheet Contents

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**ELECTRICAL SPECIFICATIONS****Standard atmospheric conditions**

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature : 25±5
Relative humidity : 40%~70%

If there is any doubt about the results, measurement shall be made within the following limits:

Ambient temperature : 25±3
Relative humidity : 40%~70%

Measure equipment

Electrical characteristics measured by S&A250B or equivalent.

Crystal cutting type

The crystal is using AT CUT (thickness shear mode).

Unit Weight:

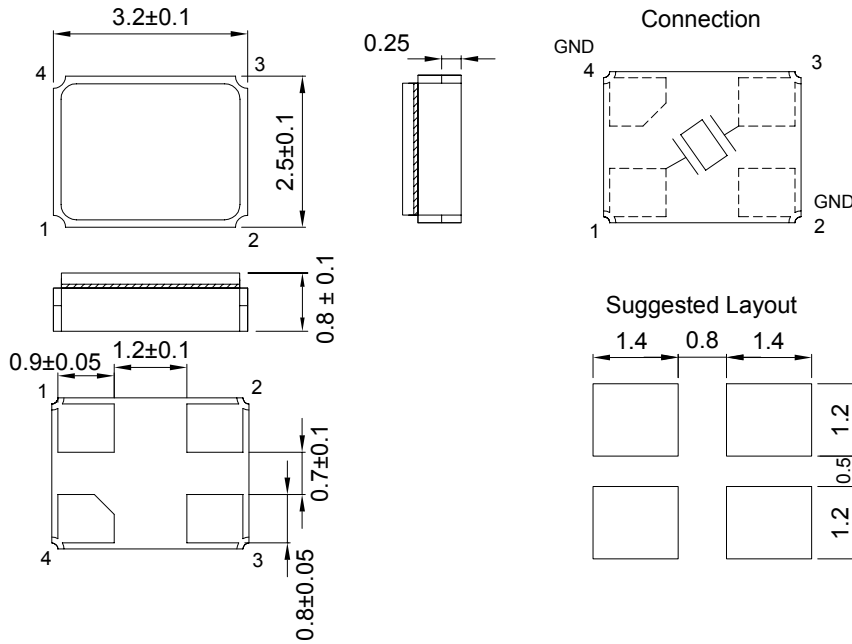
0.018±0.001 g/pcs

| | Parameters | SYM. | Electrical Spec. | | | | Notes |
|----|---------------------------|------|------------------|-----|-----|-------|--|
| | | | MIN | TYP | MAX | UNITS | |
| 1 | Nominal Frequency | FL | 12.000000 | | | MHz | - |
| 2 | Oscillation Mode | - | Fundamental | | | - | - |
| 3 | Load Capacitance | CL | 12 | | | pF | - |
| 4 | Frequency Tolerance | - | ±20 | | | ppm | at 25 ± 3 °C |
| 5 | Frequency Stability | - | ±30 | | | ppm | Over Operating Temp. Range (Reference 25 °C) |
| 6 | Operating Temperature | - | -20 | ~ | 70 | °C | - |
| 7 | Aging | - | ±5 | | | ppm | 1st Year |
| 8 | Drive Level | DL | 1 | 100 | 300 | uW | - |
| 9 | Equivalent Resistance Rr | Rr | - | - | 80 | Ω | - |
| 10 | Shunt Capacitance C0 | C0 | - | - | 7 | pF | - |
| 11 | Insulation Resistance | - | 500 | - | - | MΩ | at DC 100V |
| 12 | Storage Temperature Range | - | -40 | ~ | 85 | °C | - |

FACTORY LOCATION

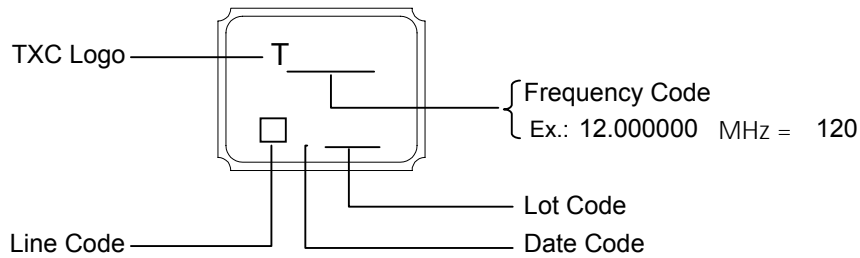
TXC (NINGBO) CORPORATION
NO.189 Huang Shan West Road, Beilun District,
Ningbo Zhejiang China

■ DIMENSIONS
(Unit:mm)



*Coplanarity of solderable areas Camber 0.10 mm Max

■ MARKING



Date Code:

| YEAR \ MONTH | | | | MONTH | | | | | | | | | | | |
|--------------|------|------|------|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| | | | | JAN | FEB | MAR | APR | MAY | JUN | JUL | AUG | SEP | OCT | NOV | DEC |
| 2005 | 2009 | 2013 | 2017 | A | B | C | D | E | F | G | H | J | K | L | M |
| 2006 | 2010 | 2014 | 2018 | N | P | Q | R | S | T | U | V | W | X | Y | Z |
| 2007 | 2011 | 2015 | 2019 | a | b | c | d | e | f | g | h | j | k | l | m |
| 2008 | 2012 | 2016 | 2020 | n | p | q | r | s | t | u | v | w | x | y | z |

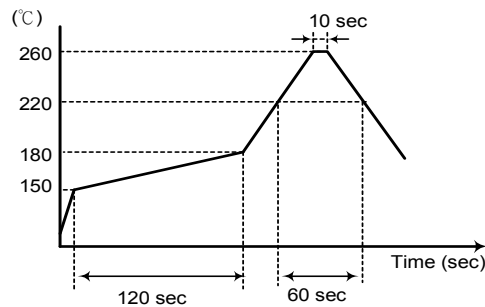
*This date code will be cycled every four years

■ SUGGESTED REFLOW PROFILE

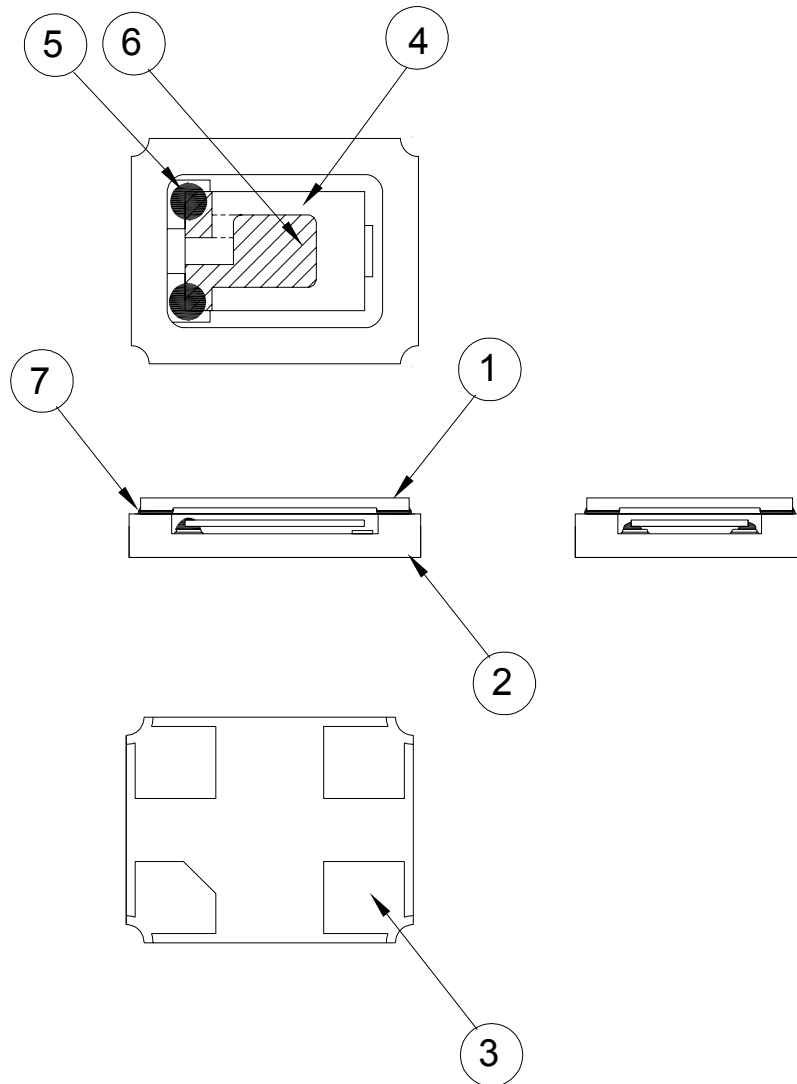
Solder melting point :220±10 °C, 60 sec. Min.
Peak Temperature: 260 ± 5 °C, 10 sec. Max.

■ SUGGESTED MANUAL SOLDER CONDITION

Temperature: 350 ± 10 °C
Time: 3 sec.
Re-solder times: twice

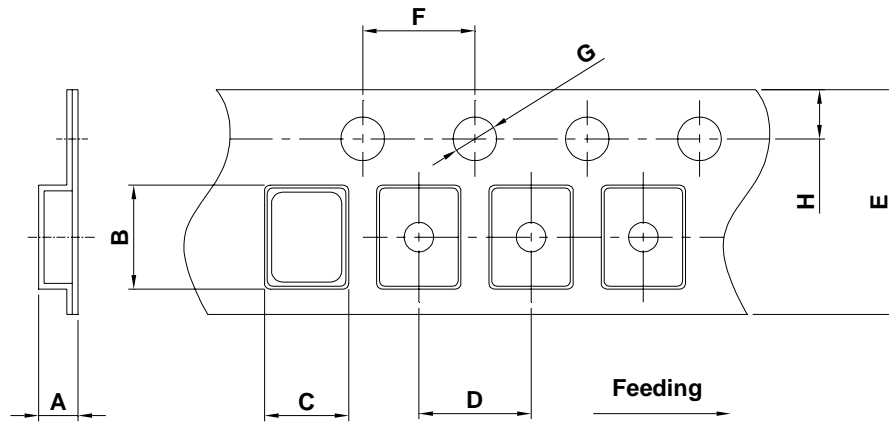


■ STRUCTURE ILLUSTRATION



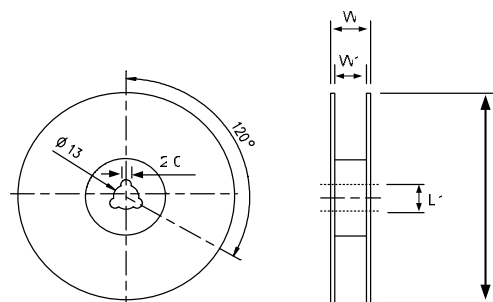
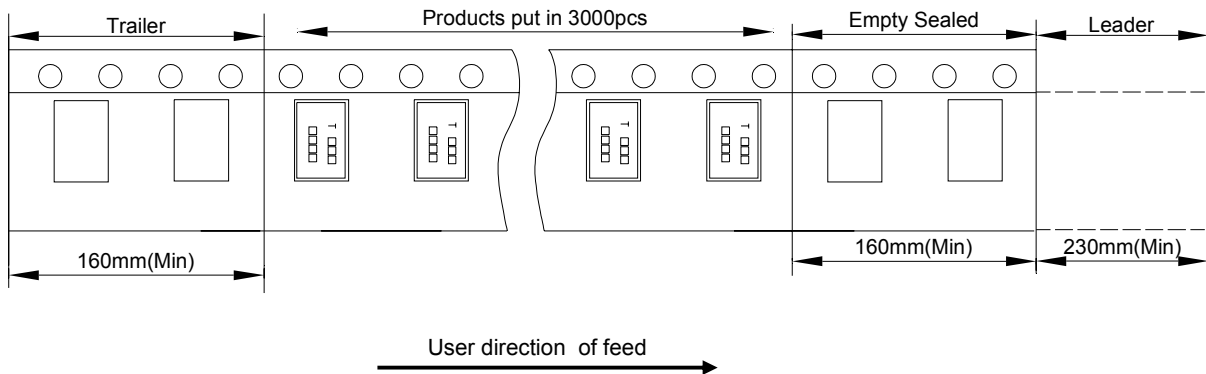
| NO | COMPONENTS | MATERIALS | FINISH/SPECIFICATIONS |
|----|---------------------|---|---|
| 1 | Cap | Ceramic (Al ₂ O ₃) | - |
| 2 | Package | Ceramic (Al ₂ O ₃) | - |
| 3 | PAD | Au | Tungsten metalize + Ni plating + Au plating |
| 4 | Crystal blank | SiO ₂ | - |
| 5 | Conductive adhesive | Resin+Ag | - |
| 6 | Electrode | Ag | - |
| 7 | Sealing Glass | Glass(PbO) | - |

■ **EMBOSS CARRIER TAPE & REEL**



| | | | | | | | | | |
|------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-------------|
| DIMENSIONS | A | B | C | D | E | F | G | H | |
| | 1.65±0.10 | 3.40±0.10 | 2.70±0.10 | 4.00±0.10 | 8.00±0.20 | 4.00±0.10 | 1.55±0.10 | 1.75±0.10 | (UNIT : mm) |

REMARK :



| | | | | | |
|------------|----------|---------|-----------|--------|-------------|
| DIMENSIONS | L | L1 | W | W1 | |
| | 178±1.00 | 13±0.50 | 11.5±0.20 | 8±0.10 | (UNIT : mm) |

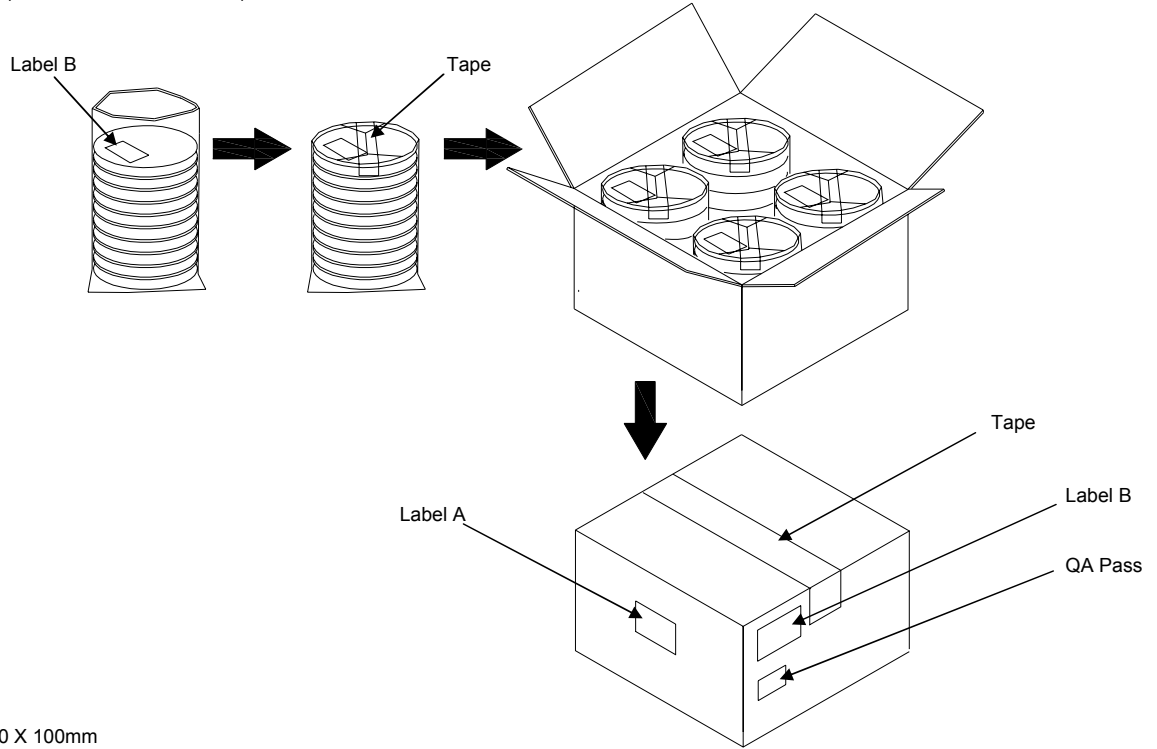
PACKING

Reel Quantity :

- 1. Reel X 6 (6 Reels)
- 2. Reel X 12 (12 Reels)
- 3. Reel X 25 (12 Reels + 13 Reels)
- 4. Reel X 50 (12 Reelsx2 + 13 Reelsx2)

Box Size:

- 1. L200 X W200 X H140mm
- 2. L200 X W200 X H250mm
- 3. L400 X W200 X H250mm
- 4. L400 X W400 X H280mm



(Label A) Size:100 X 100mm

| | |
|-------------|-------------|
| NO: | |
| P/O: | □□□□□□□□-□□ |
| P/N: | □□□□□□□□□□ |
| NUM: | □□□□□PCS |

(Label B) Size:80 X 40mm

| | | |
|------------------------|--|----------------------|
| TXC CORPORATION | | QC PASS XXXXXX/XX |
| DATE CODE: | | |
| LOT NO: | | QTY: |
| PARTS NO: | | □□□□ |
| FREQ: | | |

[STORAGE]

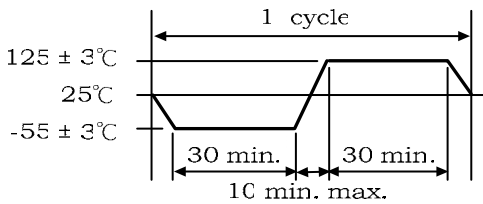
- 1.The storage time to be 1 year maximum.
- 2.Don't be caught in the rain.
- 3.The storage environment shall be 5°C ~40°C temperature and 30% ~ 75%RH humidity and free from the sun shine.
- 4.If customers have special requirements, we can paste labels according to it.

RELIABILITY SPECIFICATIONS

1.Mechanical Endurance

| No. | Test Item | Test Methods | Test Criteria |
|-----|------------------|---|---------------|
| 1.1 | Drop Test | 75 cm height,3 times on concrete floor . | A . C |
| 1.2 | Mechanical Shock | Device are shocked to half sine wave (1000 G) three mutually perpendicular axes each 3 times. 0.5 ms duration time | A . C |
| 1.3 | Vibration | Frequency range 10 ~ 2000 Hz Amplitude 1.52 mm/20G Sweep time 20 minutes Perpendicular axes each test time 4 Hrs (Total test time 12 Hrs) | A . C |
| 1.4 | Solderability | Temperature 240 ± 5 Immersing depth 0.5 mm minimum Immersion time 5 ± 1 seconds Flux Rosin resin methyl alcohol solvent (1 : 4) | E |

2.Environmental Endurance

| No. | Test Item | Test Methods | Test Criteria |
|-----|------------------------------|---|---------------|
| 2.1 | Resistance To Soldering Heat | Pre-heat temperature 125 Pre-heat time 60 ~ 120 sec. Test temperature 260 ± 5 Test time 10 ± 1 sec. | B . C . D |
| 2.2 | High Temp. Storage | + 125 ± 3 for 500 ± 12 Hrs | B . C . D |
| 2.3 | Low Temp. Storage | - 40 ± 3 for 500 ± 12 Hrs | B . C . D |
| 2.4 | Thermal Shock | Total 100 cycles of the following temperature cycle  | B . C . D |
| 2.5 | High Temp & Humidity | 85 ± 3 , RH 85% , 500 Hrs | B . C . D |

RELIABILITY SPECIFICATIONS

| Specifications | |
|----------------|---|
| A | Frequency change: Within ± 5 ppm or in customer's specification. |
| B | Frequency change: Within ± 10 ppm or in customer's specification. |
| C | Equivalent series resistance(E.S.R) change: Within $\pm 15\%$ or 10Ω (larger value). |
| D | After conditioning , quartz crystal units shall be subjected to standard atmospheric condiction for 2 hour, and measured. |
| E | Minimum 95% of immersed terminal shall be covered with new uniform solder. |

Measurement condition

Electrical characteristics measured by S&A250B or equivalent.